Pre-lamination Inlay Package Guide

1. **Purpose:** Guide the production line make the correct packaging for Pre-lamination Inlay.
2. **Range:** This document is only applicable to Pre-lamination Inlay
3. **References:** RS240-09236P

4. **Package Material:**
   - 4.1 Adhesive Tape
   - 4.2 Soft Foam
   - 4.3 Transparent plastic film, Size: 80X100 cm(according to sheet size)
   - 4.4 Packing Label, Size: 10X3.5 cm
   - 4.5 Packing Box, Size: 54.5X32X7 cm
   - 4.6 Out Box, Size: 57X43X15 cm

5. **Operational Processes**
   - 5.1 Stack the 100 pre-press cards into the middle of a transparent plastic film, as shown in Figure 1; Then fold the transparent plastic film by tapes as shown in Figure 2;
   - 5.2 First, Put soft foam in the bottom of the box as shown in Figure 3; then put the cards which have been wrapped by plastic film inside.
5.3 Put another soft foam on it and paste the packing label as Figure 5, 6.

Figure 5  
Figure 6

5.4 Seal the three edges of the box by packaging tape as Figure 7, 8.

Figure 7  
Figure 8

5.5 Put two boxes which contain 200 cards each into a larger box as shown in Figure 9. The label pasting place is also shown in Figure 9.

Figure 9
6. Notes:

6.1 Normal Products cannot be mixed with Reclaim Inlay products.

6.2 The Formats of Packing Label should be follow as Figure 10

<table>
<thead>
<tr>
<th>PACKING LABEL</th>
</tr>
</thead>
<tbody>
<tr>
<td>PRODUCTION NAME: Pre-Lamination XXXX</td>
</tr>
<tr>
<td>PRODUCTION CODE: _______ XXXX ______</td>
</tr>
<tr>
<td>Total Sheet QTY: ___________ W/O No.: ___________</td>
</tr>
<tr>
<td>Good QTY: ________________ Bad Qty: ________________</td>
</tr>
<tr>
<td>INSPEC. BY _______________ INSPEC. DATE: ________________</td>
</tr>
<tr>
<td>PACKED BY: _______________ PACKING DATE: ________________</td>
</tr>
<tr>
<td>This Packing for Prelam with ________________ Defect (s)</td>
</tr>
</tbody>
</table>

Figure 10

Remark 1: Fill in the specification and the type of the chips.
Such as 3X8 WITH MF1ICS50

Remark 2: Fill in the part number of RealSmart

Remark 3: Fill in the number of mark holes.

6.3 Products in different chip types, different part numbers and different specifications cannot be packaged in the same box.